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September 2013



J105 / J106 / J107 N-Channel Switch

Description

This device is designed for analog or digital switching applications where very low on resistance is mandatory. Sourced from Process 59.



Ordering Informations

Part Number	Marking	Package	Packing Method
J105	J105		
J106	J106	TO-92 3L	Bulk
J107	J107		

Absolute Maximum Ratings⁽¹⁾

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^{\circ}$ C unless otherwise noted.

Symbol	Parameter	Value	Units
V _{DG}	Drain-Gate Voltage	25	V
V _{GS}	Gate-Source Voltage	-25	V
I _{GF}	Forward Gate Current	10	mA
T _J , T _{stg}	Operating and Storage Junction Temperature Range	-55 to +150	°C

Notes:

- 1. These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.
- 2. These ratings are based on a maximum junction temperature of 150°C.
- 3. These are steady-state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Thermal Characteristics⁽⁴⁾

Values are at $T_A = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Maximum	Units
р	Power Dissipation	625	mW
PD	Derate above 25°C	5.0	mW/°C
R _{θJC}	Thermal Resistance, Junction to Case	125	°C/W
R _{θJA}	Thermal Resistance, Junction to Ambient	357	°C/W

Note:

4. PCB board size FR-4 76 x 114 x 0.6T mm³ (3.0 inch x 4.5 inch x 0.062 inch) with minimum land pattern size.

Electrical Characteristics

Values are at $T_A = 25^{\circ}C$ unless otherwise noted.

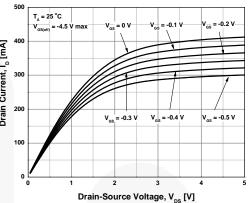
Symbol	Parameter	Test Conditions	5	Min	Max	Units	
OFF CHA	RACTERISTICS						
V _{(BR)GSS}	Gate-Source Breakdown Voltage	I _G = -10 μA, V _{DS} = 0		-25		V	
I _{GSS}	Gate Reverse Current	V_{GS} = -15 V, V_{DS} = 0			-3.0	nA	
	Gale Reverse Current	V _{GS} = -15 V, V _{DS} = 0, T _A = 100°C			-200	nA	
I _{D(off)}	Gate-Source Cut-Off Voltage	V _{DS} = -5.0 V, V _{GS} = -10 V			3.0	nA	
	Gate-Source Cut-Off Voltage	V _{DS} = 5.0 V, I _D = 1.0 mA	J105	-4.5	-10.0	V	
			J106	-2.0	-6.0		
			J107	-0.5	-4.5		
ON CHAR	ACTERISTICS						
	Zero-Gate Voltage Drain	V _{DS} = 15 V, I _{GS} = 0	J105	500		mA	
I _{DSS} Zero-Gate Voltage			J106	200			
	ourient		J107	100			
R _{DS(on)} Dra	Drain-Source On Resistance	$V_{DS} \leq 0.1 \text{ V}, V_{GS}$ = 0	J105		3.0	Ω	
			J106		6.0		
			J107		8.0		
SMALL S	GNAL CHARACTERISTICS				•		
C _{dg(on)}	Drain-Gate On Capacitance	V _{DS} = 0, V _{GS} = 10 V, f = 1.0 MHz		160	pF		
C _{sg(on)}	Source-Gate On Capacitance				100	pr	
C _{dg(off)}	Drain-Gate Off Capacitance				35	pF	
C _{sg(off)}	Source-Gate Off Capacitance					pF	

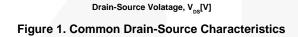
Note:

5. Pulse test: pulse width \leq 300 µs, duty cycle \leq 2.0%.

J105 / J106 / J107 — N-Channel Switch

Typical Performance Characteristic 350 T. = 25 °C 300 V_____= Drain Current, I_b [mA] Drain Current, I_b [mA] 250 200 V_{gs} = -1 V 150 100 V_{gs} = -2 V 50 0.00 0.25 0.50 0.75 1.00 1.25 1.50 1.75 2.00





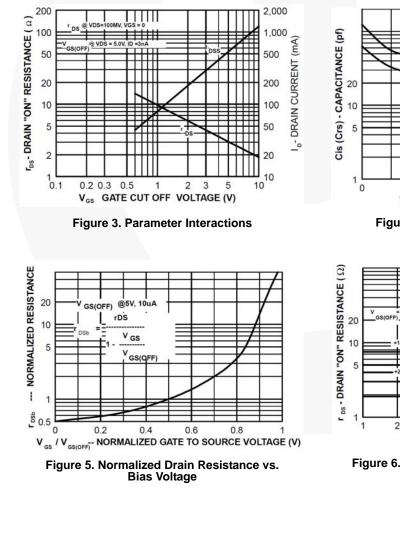
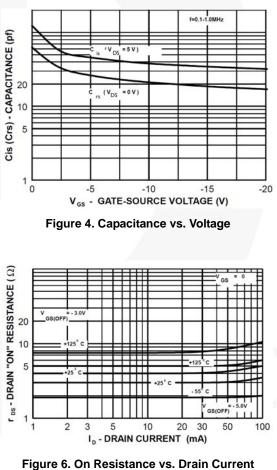
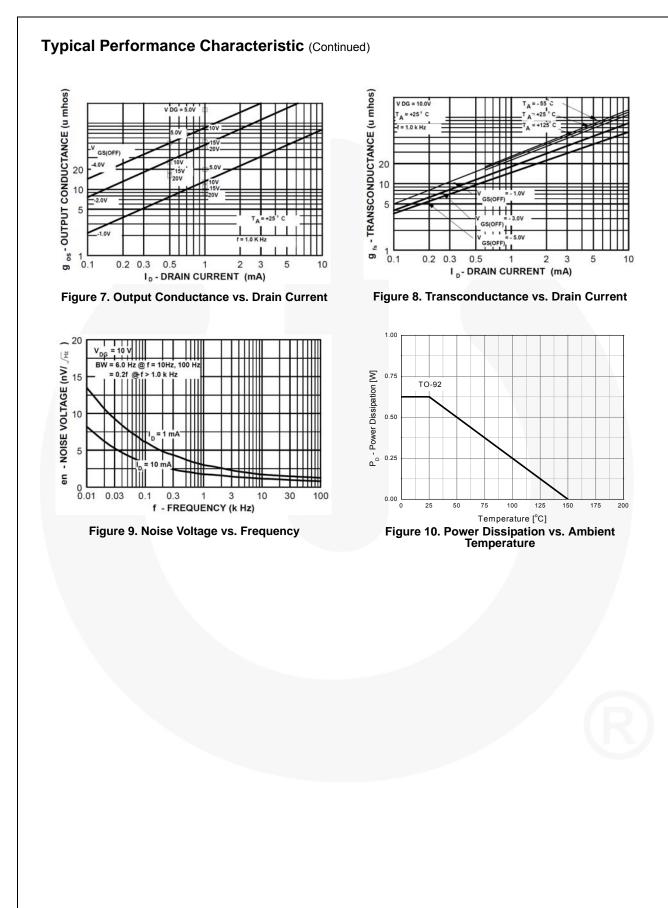


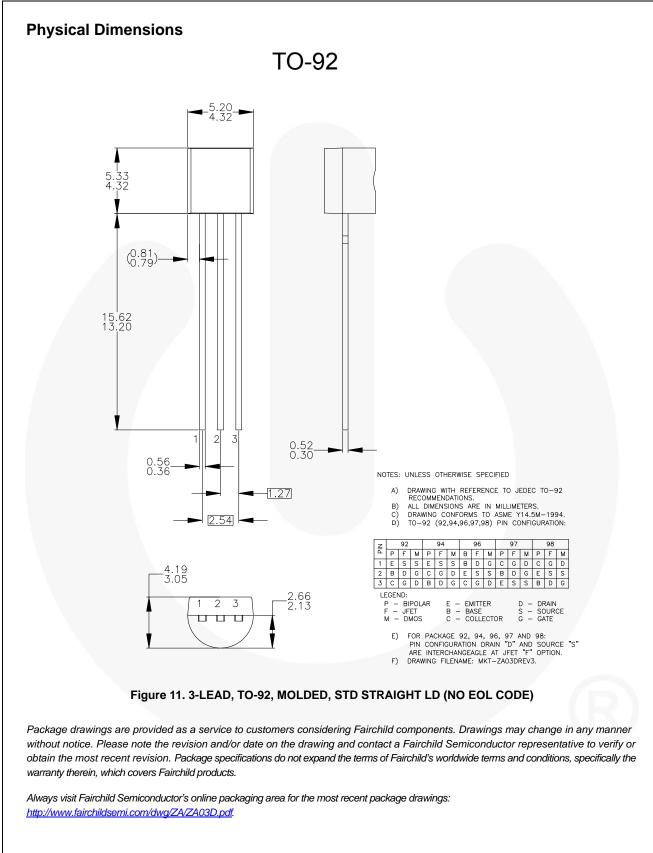
Figure 2. Common Drain-Source Characteristics



J105 / J106 / J107 — N-Channel Switch



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